

Test Laboratory: Compliance Certification Services
File Name: [Ch 1013 - RC1 SO3 8k Enhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 824.7 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

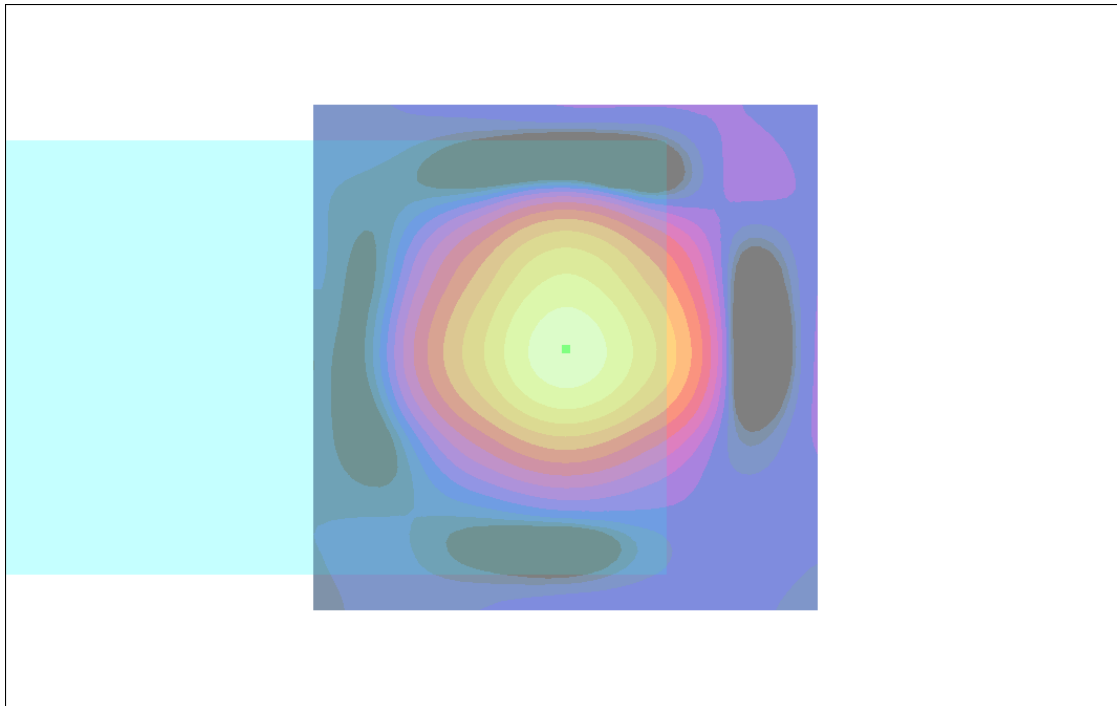
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -4.41973 dB A/m
BWC Factor = -0.206004 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [Ch 383 - RC1 SO3 8K Enhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.49 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

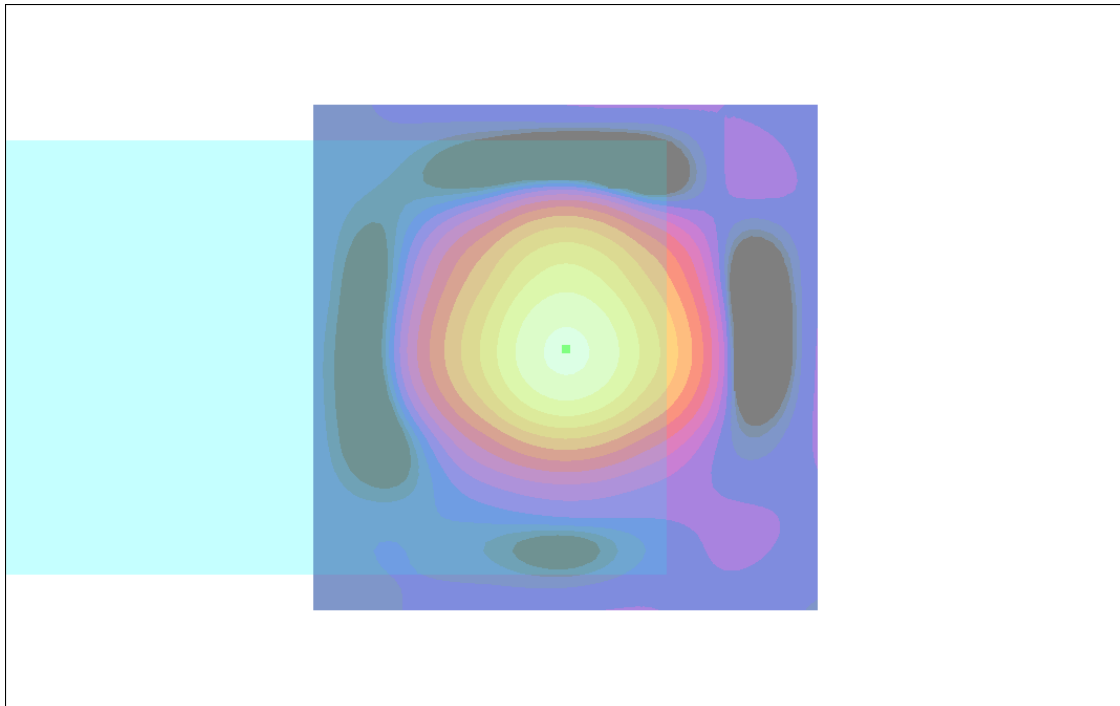
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -2.41601 dB A/m
BWC Factor = -0.206004 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [Ch 777- RC1 SO3 8k Enhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 848.31 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

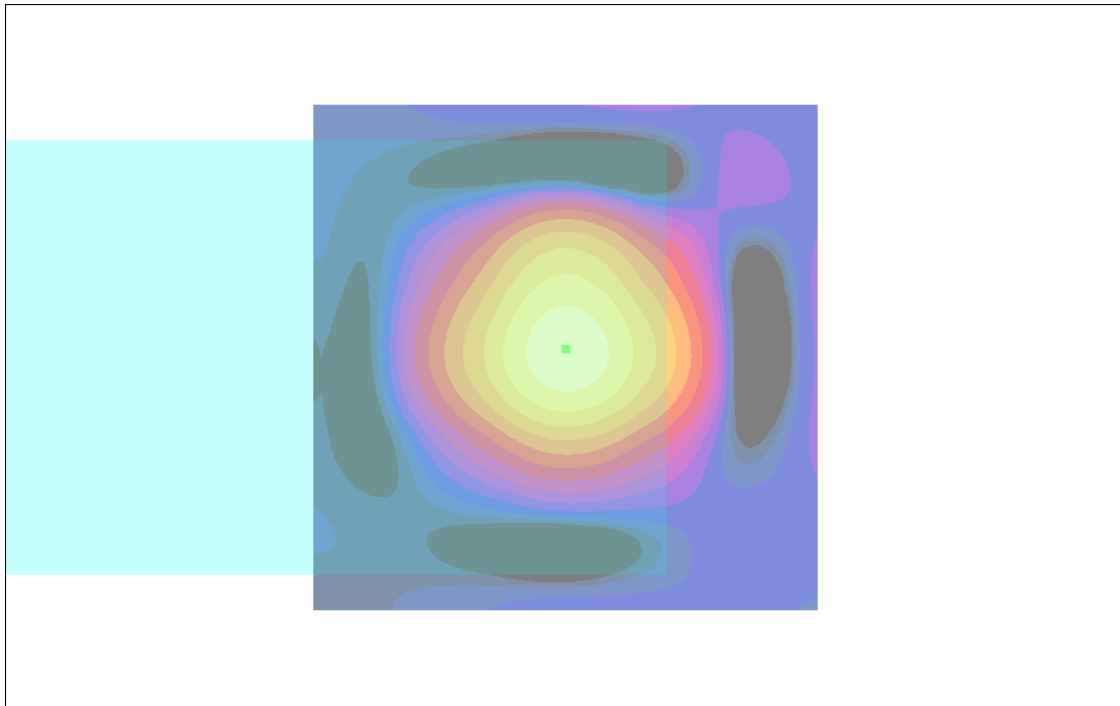
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -4.10037 dB A/m
BWC Factor = -0.206004 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [Ch 383 - RC3 SO3 8K Enhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.49 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

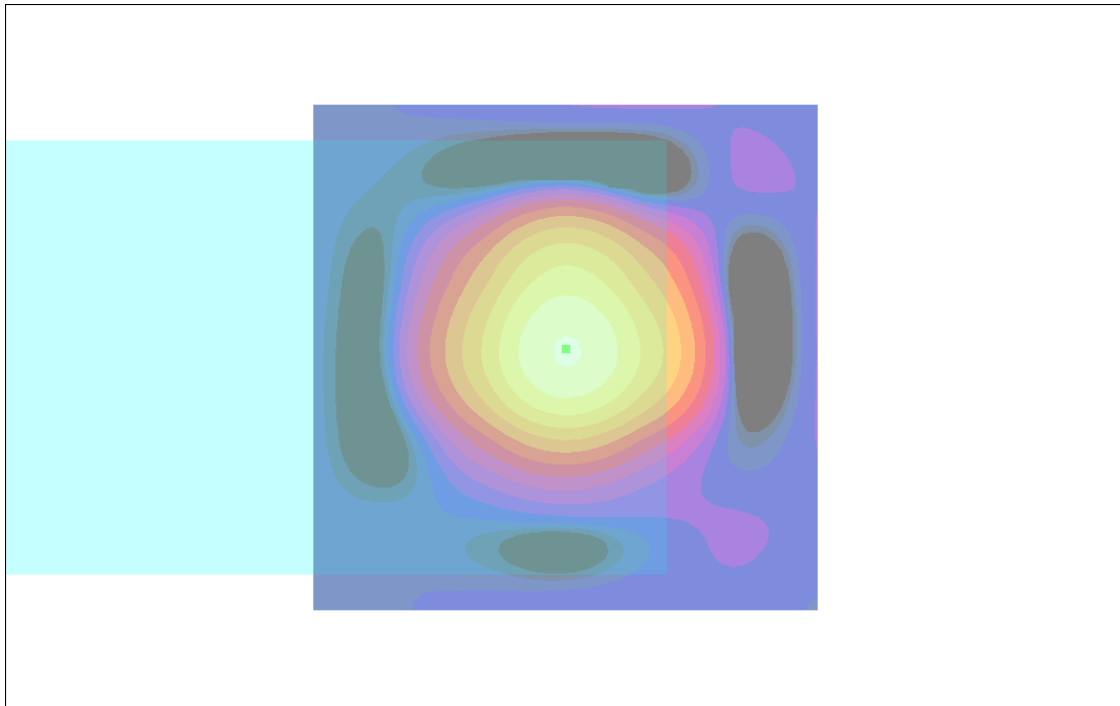
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -2.95914 dB A/m
BWC Factor = -0.204999 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [Ch 383 - RC43 SO3 8K Enhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 836.49 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

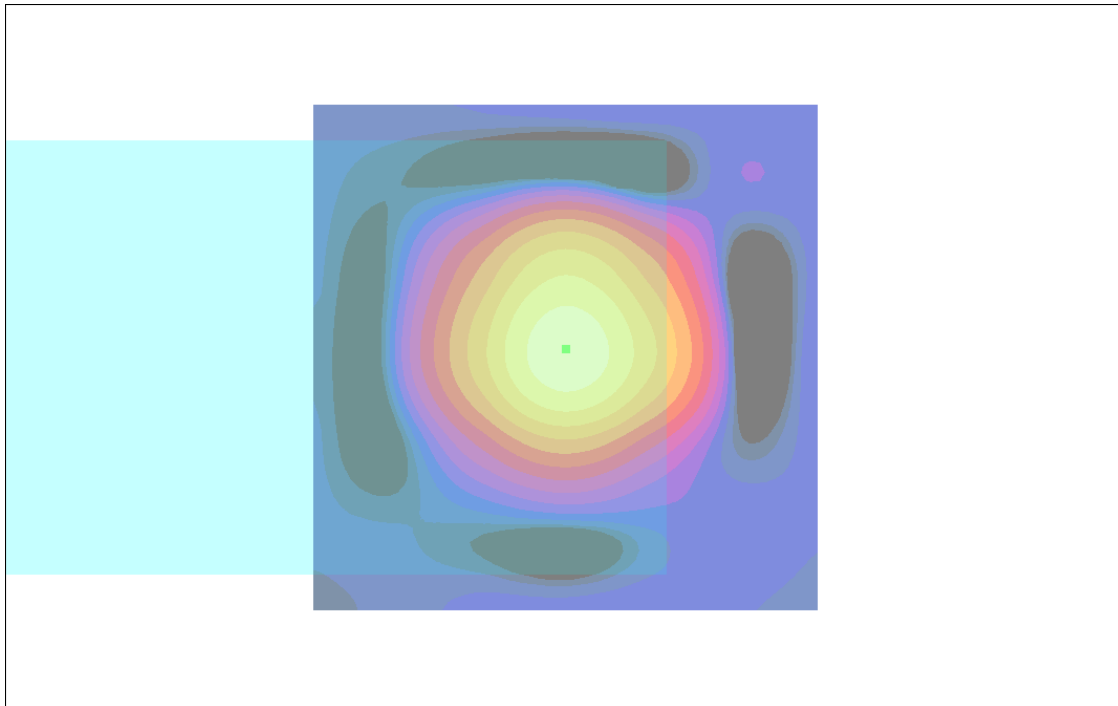
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -4.08683 dB A/m
BWC Factor = -0.206004 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [Ch 600 - RC1 SO3 8k Enhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

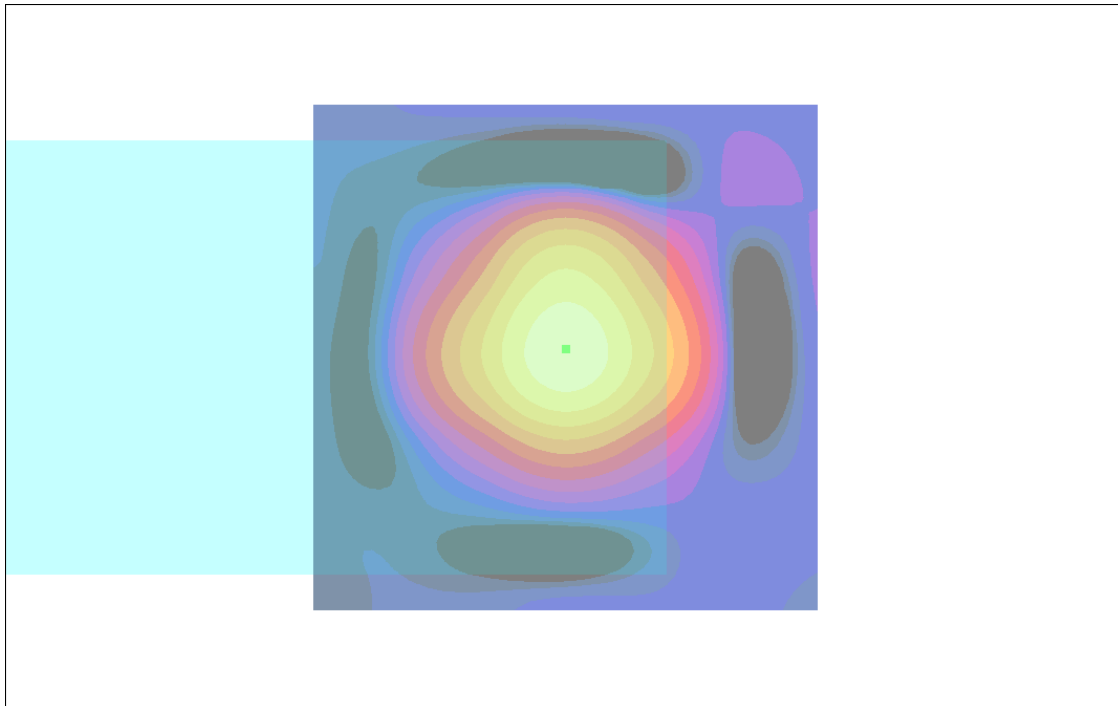
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -4.01041 dB A/m
BWC Factor = -0.206004 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [ch 25 RC3 SO3 8kEnhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1851.25 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

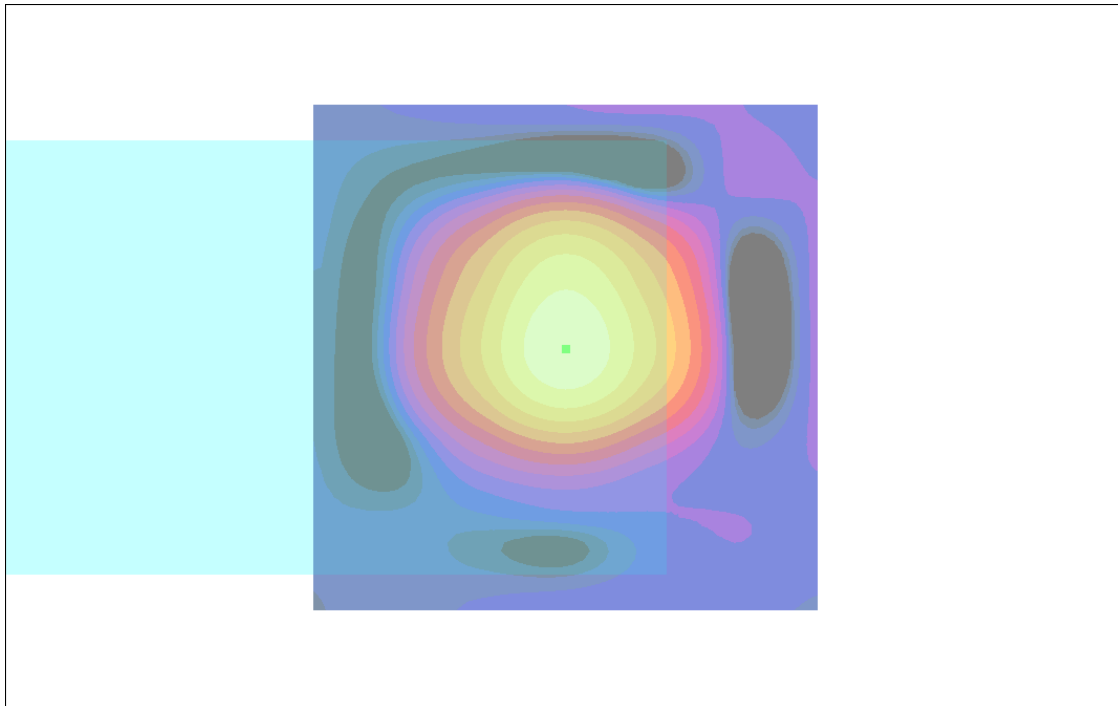
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -3.90122 dB A/m
BWC Factor = -0.204003 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [ch 600 RC3 SO3 8kEnhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

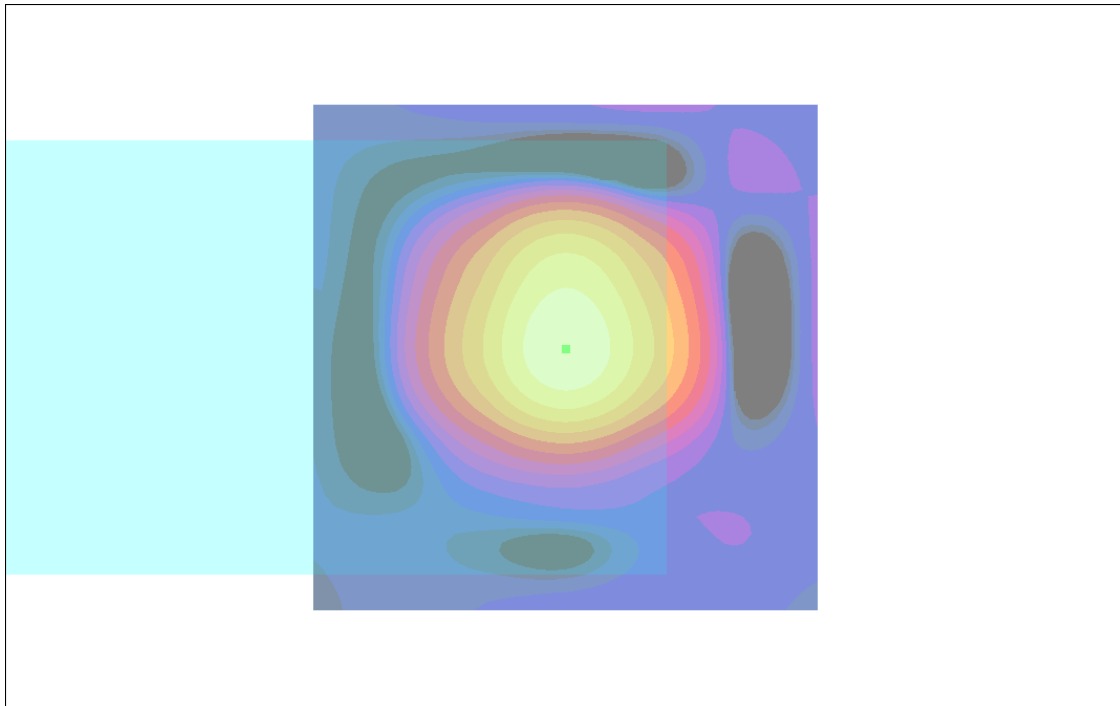
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -3.73158 dB A/m
BWC Factor = -0.204003 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [ch 1175 RC3 SO3 8kEnhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1908.75 MHz; Duty Cycle: 1:1

Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³

Phantom section: AMB with Coil Section

DASY4 Configuration:

- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

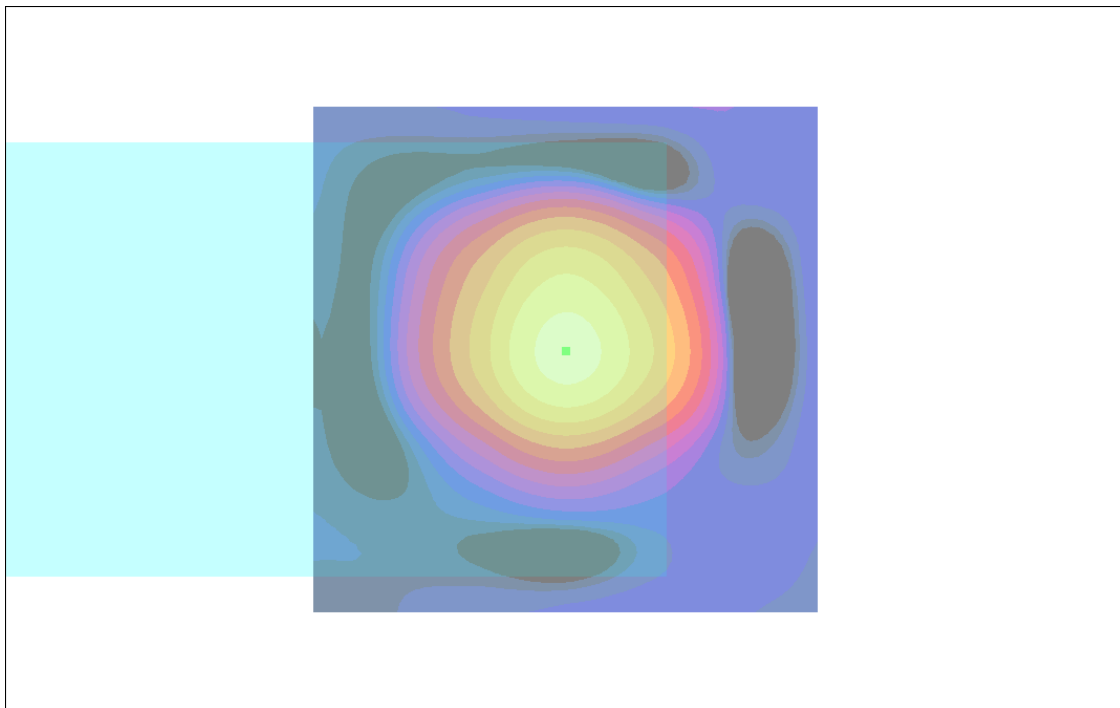
Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -4.98678 dB A/m

BWC Factor = -0.204999 dB

Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m

Test Laboratory: Compliance Certification Services
File Name: [ch 600 RC43 SO3 8kEnhanced Low.da4](#)

DUT: Kyocera; Type: K132; Serial: N/A
Program Name: HAC_TCoil_WD_Emission

Communication System: CDMA; Frequency: 1880 MHz; Duty Cycle: 1:1
Medium parameters used: $\sigma = 0$ mho/m, $\epsilon_r = 1$; $\rho = 1$ kg/m³
Phantom section: AMB with Coil Section

DASY4 Configuration:

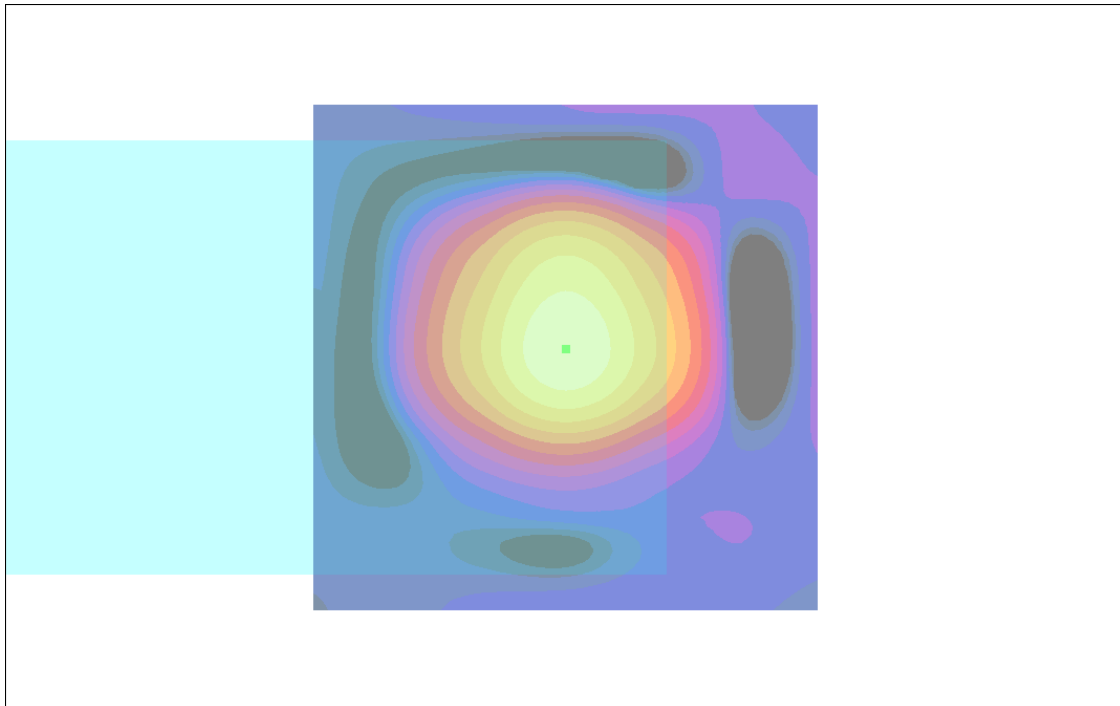
- Probe: AM1DV2 - 1012; ; Calibrated: 4/18/2006
- Sensor-Surface: 0mm (Fix Surface)
- Electronics: DAE4 SN558; Calibrated: 1/20/2006
- Phantom: HAC Test Arch with Coil; Type: SD HAC P01 BA; Serial: 100x
- Measurement SW: DASY4, V4.7 Build 44; Postprocessing SW: SEMCAD, V1.8 Build 171

Scans/z (axial) rough 50 x 50/ABM Interpolated Signal(x,y,z) (61x61x1):

Measurement grid: dx=10mm, dy=10mm

Cursor:

ABM1 = -3.80178 dB A/m
BWC Factor = -0.204003 dB
Location: 0, -0.8, 363.7 mm



0 dB = 1.00A/m